

Title (en)  
Rubber composition.

Title (de)  
Gummimasse.

Title (fr)  
Composition de caoutchouc.

Publication  
**EP 0685521 A1 19951206 (EN)**

Application  
**EP 95104259 A 19950323**

Priority  
JP 14222194 A 19940602

Abstract (en)  
A rubber composition composed of (A) a hydrocarbon rubber, (B) a vulcanizing agent and/or crosslinking agent, and (C) a hydrogenated petroleum resin having a bromine number not greater than 10 (g/100 g). The rubber composition exhibits improved processability over hydrocarbon rubber used alone but has no bad influence on the physical properties and heat resistance of its vulcanizate. It is free from any trouble involved in crosslinking with a peroxide which is often used for EPR and EPDM. Therefore, it will find general use in the rubber industry.

IPC 1-7  
**C08L 21/00**; **C08L 23/16**; **C08L 25/10**

IPC 8 full level  
**C08K 3/00** (2006.01); **C08K 5/00** (2006.01); **C08L 21/00** (2006.01); **C08L 23/16** (2006.01); **C08L 57/02** (2006.01)

CPC (source: EP KR US)  
**C08K 3/04** (2013.01 - EP US); **C08K 5/14** (2013.01 - EP US); **C08L 21/00** (2013.01 - EP KR US); **C08L 23/16** (2013.01 - EP KR US); **C08L 25/10** (2013.01 - KR); **C08L 57/02** (2013.01 - EP US); **C08L 2205/025** (2013.01 - EP US); **C08L 2312/00** (2013.01 - EP US); **C08L 2666/04** (2013.01 - EP US)

Citation (search report)

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- [A] US 5179156 A 19930112 - TAKAO HIROYOSHI [JP], et al
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BE CH DE FR GB IT LI NL

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DOCDB simple family (application)  
**EP 95104259 A 19950323**; DE 69506783 T 19950323; JP 14222194 A 19940602; KR 19950014076 A 19950531; TW 84102900 A 19950325; US 40710995 A 19950317